ULTRA MINIATURE 2-POLES 2A (SLIM PROFILE SIGNAL RELAY)

FTR-B4 Series

RoHS compliant

■ FEATURES

- DPDT 2A
- Ultra miniature slim type relay for surface mounting

Height: 9.3 mm maximum (THT)

10 mm maximum (SMT)

Weight: Approximately 1.0 g

- Conforms to Bellcore & FCC part 68, and Telcordia & FCC part 68
- Conforms to UL1950 / CSA 950, IEC 950 / EN60950 spacing and high breakdown voltage

Clearance: 1.0mm Creepage: 1.6mm

Basic insulation, 150V working voltage, pollution degree 2

- · High reliable birfuracted gold overlay silver contact
- Low power consumption 140 mV (standard), 100 mW (latching)
- RoHS compliant since date code: 0430B8
 Please see page 8 for more information

ORDERING INFORMATION

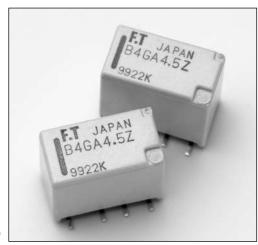


Remarks: Actual marking on relay would not carry code FTR and be as below: Ordering code Actual marking

Notes: *FTR-B4CA4.5Z → B4CA4.5Z

- Only surface mount types (G and S) are applicable
- All relays are packaged in tubes unles P/N ends with -B05





■ PART NUMBERS

Standard type

Ordering Part Number	Series	Terminal Type	Operation	Coil Voltage	Contact Material
FTR-B4CA1.5Z		C: through		1.5	
FTR-B4CA003Z				3	
FTR-B4CA4.5Z				4.5	
FTR-B4CA006Z				6	Z: Au-Ag-Ni P: Au-Ag-Pd
FTR-B4CA009Z		11010		9	
FTR-B4CA012Z				12	
FTR-B4CA024Z				24	
FTR-B4GA1.5Z				1.5	
FTR-B4GA003Z				3	
FTR-B4GA4.5Z	1	G: surface mount A: r	A: non-latch	4.5	
FTR-B4GA006Z	FTR-B3			6	
FTR-B4GA009Z				9	
FTR-B4GA012Z				12	
FTR-B4GA024Z				24	
FTR-B4SA1.5Z		S: space sav- ing surface mount		1.5	
FTR-B4SA003Z				3	
FTR-B4SA4.5Z				4.5	
FTR-B4SA006Z				6	
FTR-B4SA009Z				9	
FTR-B4SA012Z				12	
FTR-B4SA024Z				24	

Latching type (1 coil)

Ordering Part Number	Series	Terminal Type	Operation	Coil Voltage	Contact Material	
FTR-B4CB1.5Z		C: through		1.5		
FTR-B4CB003Z				3		
FTR-B4CB4.5Z				4.5		
FTR-B4CB006Z				6		
FTR-B4CB009Z		TIOIC		9		
FTR-B4CB012Z				12	Z: Au-Ag-Ni P: Au-Ag-Pd	
FTR-B4CB024Z			B: latch	24		
FTR-B4GB1.5Z		G: surface mount		1.5		
FTR-B4GB003Z				3		
FTR-B4GB4.5Z	1			4.5		
FTR-B4GB006Z	FTR-B3			6		
FTR-B4GB009Z			mount		9	1. Ad-Ag-1 d
FTR-B4GB012Z				12		
FTR-B4GB024Z				24		
FTR-B4SB1.5Z		S: space sav- ing surface mount		1.5		
FTR-B4SB003Z				3		
FTR-B4SB4.5Z				4.5		
FTR-B4SB006Z				6		
FTR-B4SB009Z				9		
FTR-B4SB012Z				12		
FTR-B4SB024Z				24		

■ COIL DATA CHART

Standard type

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Coil Voltage	Nominal Voltage (VDC)	Max. Coil Voltage*1	Coil Resistance (±10%)	Must Operate Voltage*2	Must Release Voltage*2	Nominal Power (mW)
1.5	1.5	3.53 VDC	16.1 Ω	1.13 VDC	0.15 VDC	
003	3	7.05 VDC	64.3 Ω	2.25 VDC	0.3 VDC	
4.5	4.5	10.58 VDC	145 Ω	3.38 VDC	0.45 VDC	140
006	6	14.10 VDC	257 Ω	4.5 VDC	0.6 VDC	140
009	9	21.15 VDC	579 Ω	6.75 VDC	0.9 VDC	
012	12	28.20 VDC	1,028 Ω	9.0 VDC	1.2 VDC	
024	24	56.40 VDC	2,504 Ω	18.0 VDC	2.4 VDC	230

Latching type (1 coil)

Coil Voltage	Nominal Voltage (VDC)	Max. Coil Voltage* 1	Coil Resistance (±10%)	Must Operate Voltage* ²	Must Release Voltage*2	Set/Re-set current	Nominal Power (mW)
1.5	1.5	3.53 VDC	22.5 Ω	1.13 VDC	-0.13 VDC	50mA	
003	3	7.05 VDC	90 Ω	2.25 VDC	-2.25 VDC	25mA	
4.5	4.5	10.58 VDC	203 Ω	3.38 VDC	-3.38 VDC	17mA	100
006	6	14.10 VDC	360 Ω	4.5 VDC	-4.5 VDC	13mA	100
009	9	21.15 VDC	810 Ω	6.75 VDC	-6.75 VDC	8mA	
012	12	28.20 VDC	1,440 Ω	9.0 VDC	-9.0 VDC	6mA	
024	24	56.40 VDC	4,800 Ω	18.0 VDC	-18.0 VDC	4mA	120

^{*} Pulse driven

Note: All values in the table are measured at 20°C.

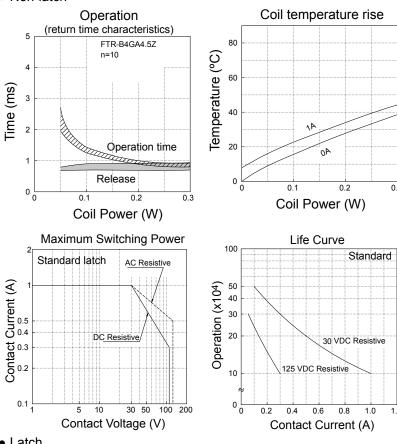
■ SPECIFICATIONS

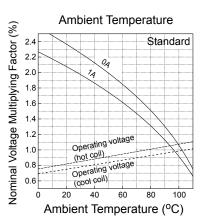
			Standard Type	Latching Type	
			FTR-B4 () A FTR-B4-C () B		
Contact	Arrangement		2 Form C		
	Contact material		Gold overlay silver nickel / Gold overlay silver palladium		
	Contact type		Bifurcated contact (cross-bar)		
	Contact resistance (ini	tial value)	100mΩ maximum at 6VDC 1		
	Contact rating		30 VDC 1A, 125 VAC 0.3 A (resistive)		
	Maximum carrying cur	rent	2A		
	Maximum switching po	ower	62.5 VA / 30W		
	Maximum switching voltage Minimum switching load*		250 VAC/ 220 VDC		
			10m VDC, 0.01mA*		
Coil	Nominal power (at 20°	C)	140 mW up to 230 mW	100 mW up to 130 mW	
	Operate power (at 20°	C)	80 mW up to 130 mW	57 mW up to 68 mW	
	Operating temperature	(no frost)	-40°C to +85°C		
Time value	Operate (at nominal vo	oltage, without bounce)	3ms maximum	3ms maximum (set)	
	Release (at nominal vo	oltage, without bounce)	3ms maximum	3ms maximum (reset)	
Life	Mechanical		50 x 10 ⁶ operations	20 x 10 ⁶ operations	
	Electrical (resistive load)	DC load	100 x 10 ³ ops. min. at 1A, 30 VDC (at 0.5 Hz)		
		AC load	100 x 10 ³ ops. min. at 0.3A, 125VAC (at 0.5 Hz)		
Vibration	Misoperation		10 to 55 Hz at double amplitude of 3 mm		
resistance	Endurance		10 to 55 Hz at double amplitude of 5 mm		
Shock	Misoperation		Min. 750 m/s ²		
resistance	Endurance		Min. 1,000 m/s ²		
Weight			Approximately 1.0 g		
US/CSA Contact rating			0.5A, 125 VAC; 1A, 30 VDC; 0.3A, 110 VDC		

^{*1} Minimum switching loads mentioned above are reference values. Please perform the confirmation test with the actual load before production since reference values may vary according to switching frequencies, envir onmental conditions and expected reliability levels.

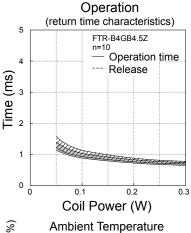
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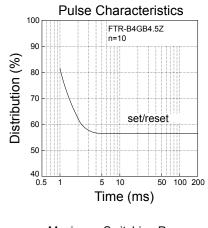
Non-latch

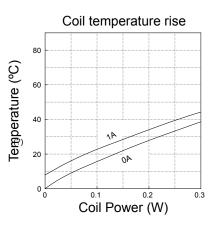


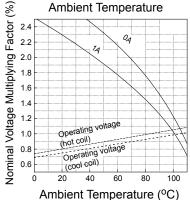


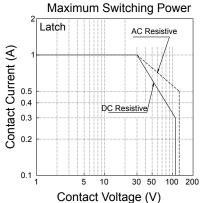
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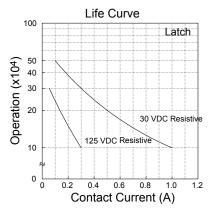






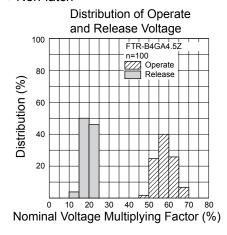


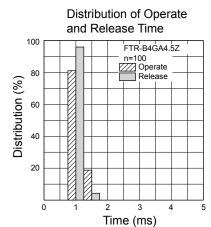


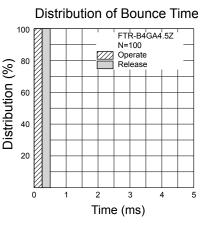


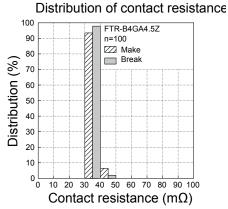
■ REFERENCE DATA

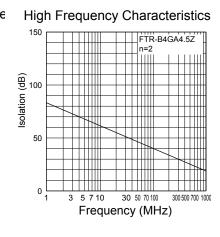
Non-latch

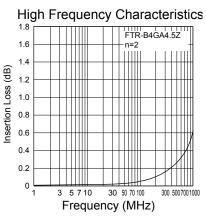




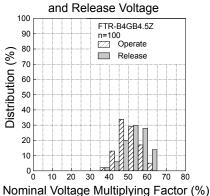


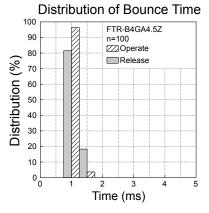


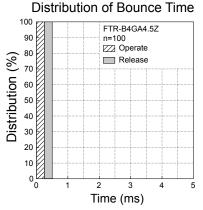




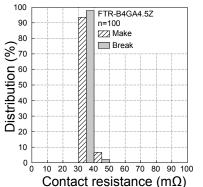


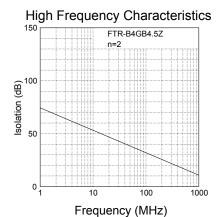


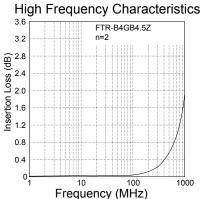




Distribution of contact resistance

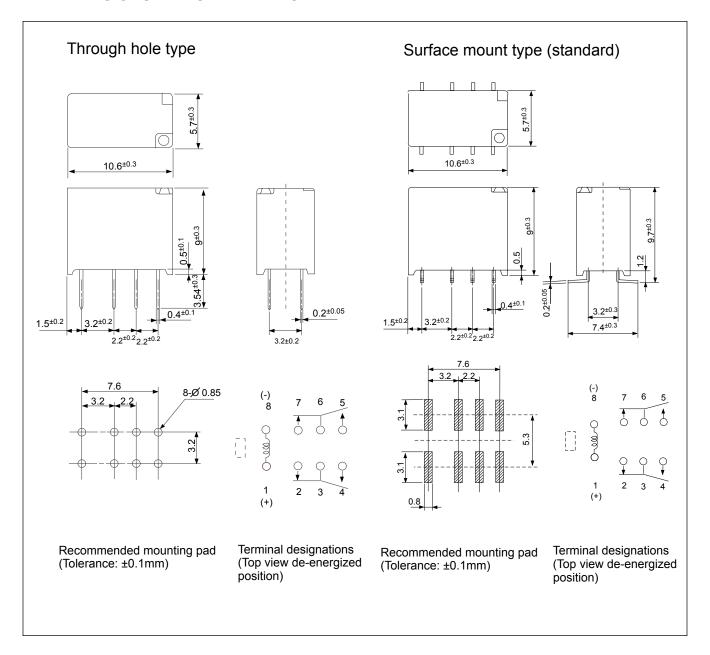






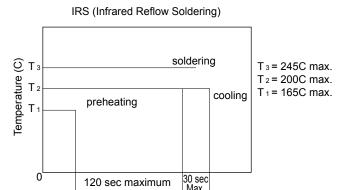
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■ DIMENSIONS AND SCHEMATICS



DIMENSIONS AND SCHEMATICS Space saving 10.6^{±0.3} Q±0.3 .4±0.1 3.2^{±0.3} 1.5^{±0.2} $3.2^{\pm0.2}$ 5.7^{±0.3} 2.2^{±0.2}2.2^{±0.2} 3.2 _ 2.2 (-) 8 0 1 2 (+)

■ RECOMMENDED SOLDERING CONDITIONS (TEMPERATURE PROFILE)



Note:

- 1.Temperature profiles show the tempera ture of PC board surface.
- 2. Please perform soldering test with your actual PC board before mass produc tion, since the temperatures of PC board surfaces vary according to the size of PC board, status of parts mount ing and heating method.

■ PRECAUTIONS

Recommended mounting pad

(Tolerance: ±0.1mm)

- For details on general precautions, refer to the section on technical descriptions.

Terminal designations

position)

(Top view de-energized

- Since this is a polar relay, follow the instructions of the internal wiring diagram for the +- connections of the coil.
- Note that the terminal array and internal wiring of the surface mount relay are a top view.

RoHS Compliance and Lead Free Relay Information

1. General Information

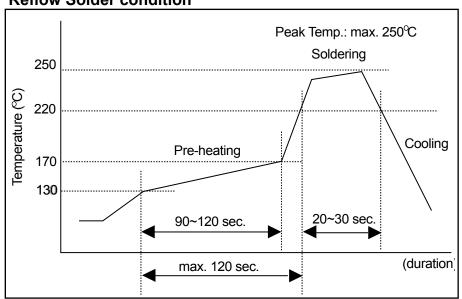
- Relays produced after the specific date code that is indicated on each data sheet are lead-free now. All of our signal and power relays are lead-free. Please refer to Lead-Free Status Info. (http://www.fujitsu.com/us/downloads/MICRO/fcai/relays/lead-free-letter.pdf)
- Lead free solder paste currently used in relays is Sn-3.0Ag-0.5Cu. From February 2005 forward Sn-3.0CU-Ni will be used for the FTR-B3 and FTR-B4 series relays.
- All signal and power relays also comply with RoHS. Please refer to individual data sheets. Relays that are RoHS compliant do not contain the 5 hazardous materials that are restricted by RoHS directive (lead, mercury, chromium IV, PBB, PBDE).
- It has been verified that using lead-free relays in leaded assembly process will not cause any problems (compatible).
- "LF" is marked on each outer and inner carton. (No marking on individual relays).
- To avoid leaded relays (for lead-free sample, etc.) please consult with area sales office.
 - We will ship leaded relays as long as the leaded relay inventory exists.

Note: Cadmium was exempted from RoHS on October 21, 2005. (Amendment to Directive 2002/95/EC)

2. Recommended Lead Free Solder Profile

 Recommended solder paste Sn-3.0Ag-0.5Cu amd Sm-3.0 Cu-Ni (only FTR-B3 and FTR-B4 from February 2005.

Reflow Solder condition



Flow Solder condition:

Pre-heating: maximum 120°C Soldering: dip within 5 sec. at 260°C soler bath

Solder by Soldering Iron:

Soldering Iron

Temperature: maximum 360°C Duration: maximum 3 sec.

We highly recommend that you confirm your actual solder conditions

3. Moisture Sensitivity

• Moisture Sensitivity Level standard is not applicable to electromechanical realys.

4. Tin Whisker

 SnAgCu and SnCuNi solder is known as low risk of tin whisker. No considerable length whisker was found by our in-house test.

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